U3B-M3, U3C-M3, U3D-M3

Vishay General Semiconductor

# **Surface Mount Ultrafast Plastic Rectifier**



DO-214AB (SMC)

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	3.0 A				
V <sub>RRM</sub>	100 V, 150 V, 200 V				
I <sub>FSM</sub>	100 A				
t <sub>rr</sub>	20 ns				
$V_F$ at $I_F$ = 3.0 A	0.74 V				
T <sub>J</sub> max.	150 °C				
Package	DO-214AB (SMC)				
Diode variations	Single die				

### **FEATURES**

- Oxide planar chip junction
- Ultrafast recovery time
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **TYPICAL APPLICATIONS**

For us in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

## **MECHANICAL DATA**

Case: DO-214AB (SMC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - RoHS-compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER		SYMBOL	U3B	U3C	U3D	UNIT	
Device marking code			U3B	U3C	U3D		
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	100	150	200	V	
Maximum average forward rectified current (fig. 1)	T <sub>M</sub> = 134 °C	I <sub>F(AV)</sub> <sup>(1)</sup>	2.0			А	
	T <sub>M</sub> = 125 °C	I <sub>F(AV)</sub> <sup>(2)</sup>	3.0				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	100			A	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150			°C	

### Notes

<sup>(1)</sup> Free air, mounted on recommended copper pad area

<sup>(2)</sup> Units mounted on PCB with 0.47" x 0.47" (12 mm x 12 mm) copper pad areas









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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 3.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.85	0.90	v
		T <sub>A</sub> = 100 °C		0.74	0.83	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	10	
		T <sub>A</sub> = 100 °C	IR (=/	250	500	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	T <sub>A</sub> = 25 °C	t <sub>rr</sub>	-	20	ns
	$ I_F = 3.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, \text{ I}_{rr} = 0.1 \text{ I}_{RM} $	T <sub>A</sub> = 25 °C		25	30	
		T <sub>A</sub> = 100 °C		35	50	
Storage charge	$ I_F = 3.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, \text{ I}_{rr} = 0.1 \text{ I}_{RM} $	T <sub>A</sub> = 25 °C	Q <sub>rr</sub>	9	15	nC
		T <sub>A</sub> = 100 °C		22	35	
Typical junction capacitance	4.0 V, 1 MHz		CJ	25	-	pF

Notes

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  40 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	U3B	U3C	U3D	UNIT	
Typical thermal resistance	R <sub>0JA</sub> <sup>(1)</sup>	92			°C/W	
	R <sub>0JM</sub> <sup>(1)</sup>	10			0/10	

### Note

<sup>(1)</sup> Free air, mounted on recommended copper pad area. Thermal resistance R<sub>0JA</sub> - junction to ambient, R<sub>0JM</sub> - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
U3D-M3/57T	0.239	57T	850	7" diameter plastic tape and reel		
U3D-M3/9AT	0.239	9AT	3500	13" diameter plastic tape and reel		

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

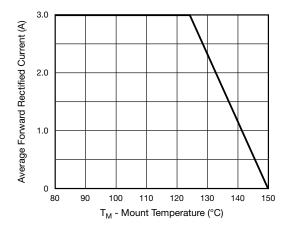


Fig. 1 - Maximum Forward Current Derating Curve

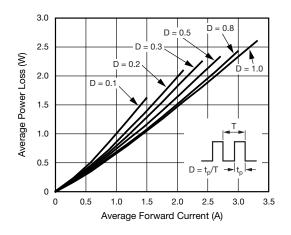


Fig. 2 - Forward Power Loss Characteristics

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2

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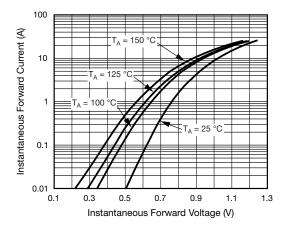


Fig. 3 - Typical Instantaneous Forward Characteristics

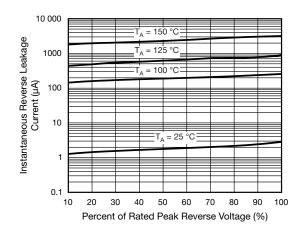


Fig. 4 - Typical Reverse Leakage Characteristics



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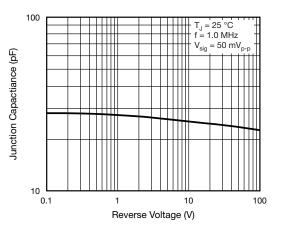


Fig. 5 - Typical Junction Capacitance

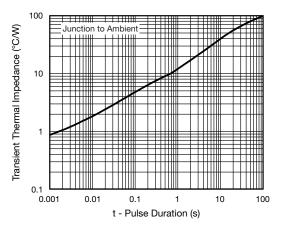
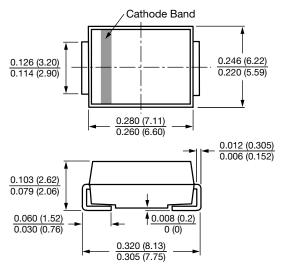
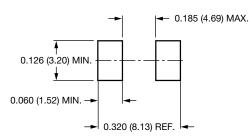


Fig. 6 - Typical Transient Thermal Impedance





#### Mounting Pad Layout



Revision: 23-Oct-13

3

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